



EMIF06-MSD03F3

6-line low capacitance IPAD™ for micro-SD card
with EMI filtering and ESD protection

Features

- EMI low-pass filter
- ESD protection ± 15 kV (IEC 61000-4-2)
- Integrated pull up resistors to prevent bus floating when no card is connected
- 208 MHz clock frequency compatible with SDR104 mode (SD3.0)
- Lead-free package
- Coated version option on request
- Electrical card detect option

Benefits

- Low power consumption
- Easy layout thanks to smart pin-out configuration
- Very low PCB space consumption
- High reliability offered by monolithic integration
- Reduction of parasitic elements thanks to CSP integration

Complies with the following standards:

- IEC 61000-4-2 level 4:
 - 15 kV (air discharge)
 - 8 kV (contact discharge)

Application

Micro (T-Flash) secure digital memory card in:

- Mobile phones
- Communication systems

Description

The EMIF06-MSD03F3 is a highly integrated device based on IPAD technology offering two functions: ESD protection to comply with IEC standard, and EMI filtering to reject mobile phone frequencies.

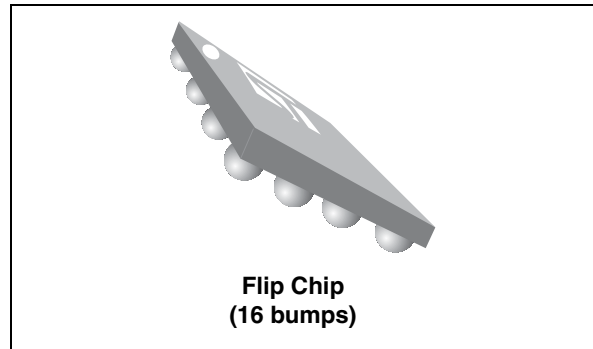
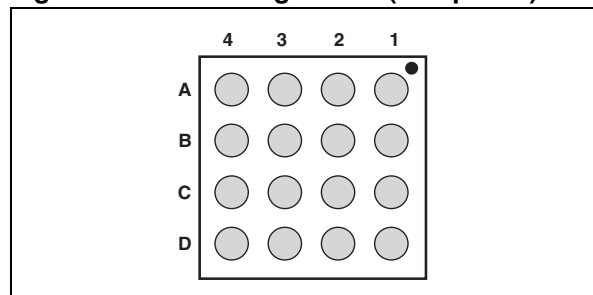


Figure 1. Pin configuration (bump side)



TM: IPAD is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute ratings (limiting values)

| Symbol | Parameter | Value | Unit |
|------------------|--------------------------------------|---------------|------|
| V _{PP} | ESD discharge IEC 61000-4-2, level 4 | | |
| | air discharge, card side | 15 | kV |
| | contact discharge, card side | 8 | |
| | air discharge, IC side | 2 | |
| | contact discharge, ICside | 2 | |
| T _j | Maximum junction temperature | 125 | °C |
| T _{op} | Operating temperature range | - 40 to + 85 | °C |
| T _{stg} | Storage temperature range | - 55 to + 150 | °C |

Figure 2. EMIF06-MSD03F3 configuration

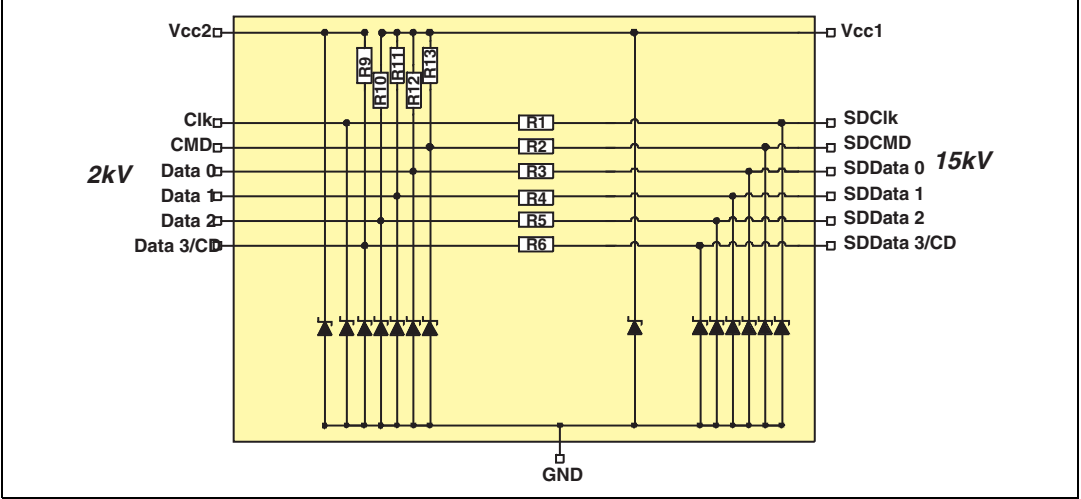


Table 2. Pin configuration

| Pin | Signal | Pin | Signal |
|-----|------------------|-----|------------------|
| A1 | DATA0 | C1 | CMD |
| A2 | DATA1 | C2 | V _{cc2} |
| A3 | SDDATA1 | C3 | V _{ss} |
| A4 | SDDATA0 | C4 | SDCMD |
| B1 | CLK | D1 | DATA3/CD |
| B2 | V _{cc1} | D2 | DATA2 |
| B3 | V _{ss} | D3 | SDDATA2 |
| B4 | SDCLK | D4 | SDDATA3/CD |

Table 3. Electrical characteristic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|------------------------|-----------------------------|---|------|------|------|------------------|
| V_{BR} | Breakdown voltage | $I_R = 1 \text{ mA}$ | 14 | 16 | | V |
| I_{RM} | Leakage current at V_{RM} | $V_{RM} = 3 \text{ V}$ | | | 0.1 | μA |
| R1, R2, R3, R4, R5, R6 | Serial resistance | Tolerance $\pm 10 \%$, matching $\pm 2 \%$ | | 40 | | Ω |
| R9, R10, R11, R12 | Pull-up resistance | Tolerance $\pm 10 \%$, matching $\pm 2 \%$ | | 50 | | $\text{k}\Omega$ |
| R13 | Pull-up resistance on CMD | Tolerance $\pm 10 \%$ | | 15 | | $\text{k}\Omega$ |
| C_{line} | Data line capacitance | $V = 0 \text{ V}$, $F = 10 \text{ MHz}$, $V_{OSC} = 30 \text{ mV}$ | | 10 | 12 | pF |
| | | $V = 1.8 \text{ V}$, $F = 10 \text{ MHz}$, $V_{OSC} = 30 \text{ mV}$ | | 7.5 | 10 | |
| | | $V = 2.9 \text{ V}$, $F = 10 \text{ MHz}$, $V_{OSC} = 30 \text{ mV}$ | | | 9 | |
| F_0 | Cut-off frequency | $S_{21} = -3 \text{ dB}$ | | 550 | | MHz |
| t_R, t_F | Rise and fall time | $C_{load} = 10 \text{ pF}$, low-ref = 0.58 V , high-ref = 1.27 V , $V_{DDIO} = 1.8 \text{ V}$ | | 0.98 | | ns |

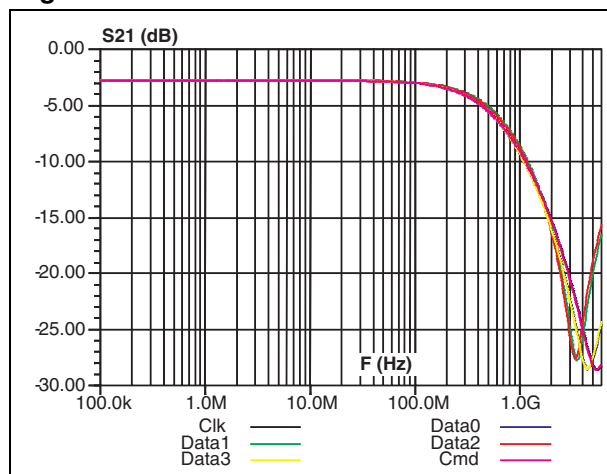
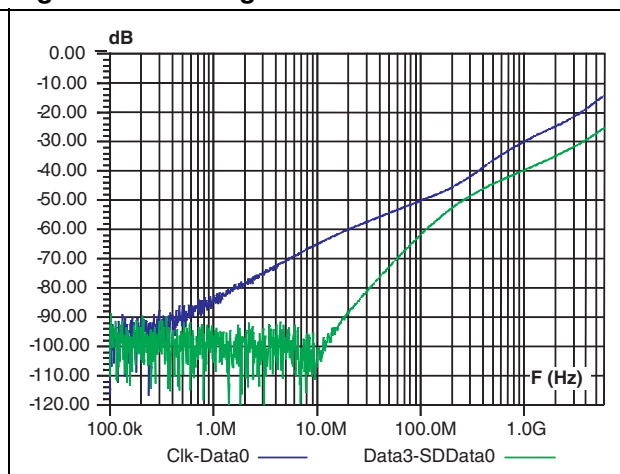
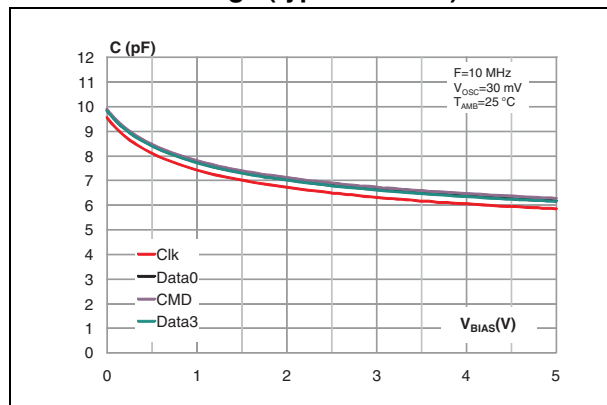
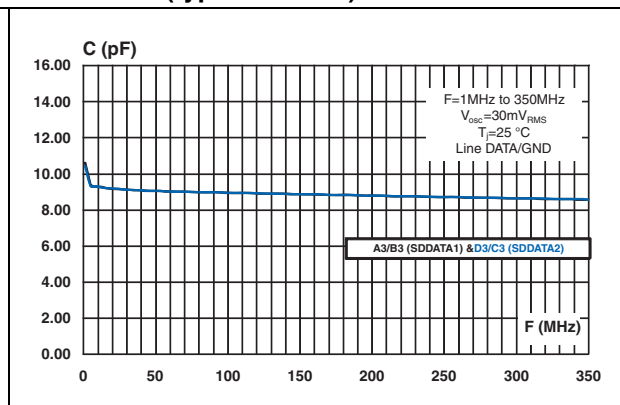
Figure 3. S21 attenuation measurements**Figure 4. Analog crosstalk measurements****Figure 5. Line capacitance versus applied voltage (typical values)****Figure 6. Line capacitance versus frequency (typical values)**

Figure 7. Digital crosstalk measurements

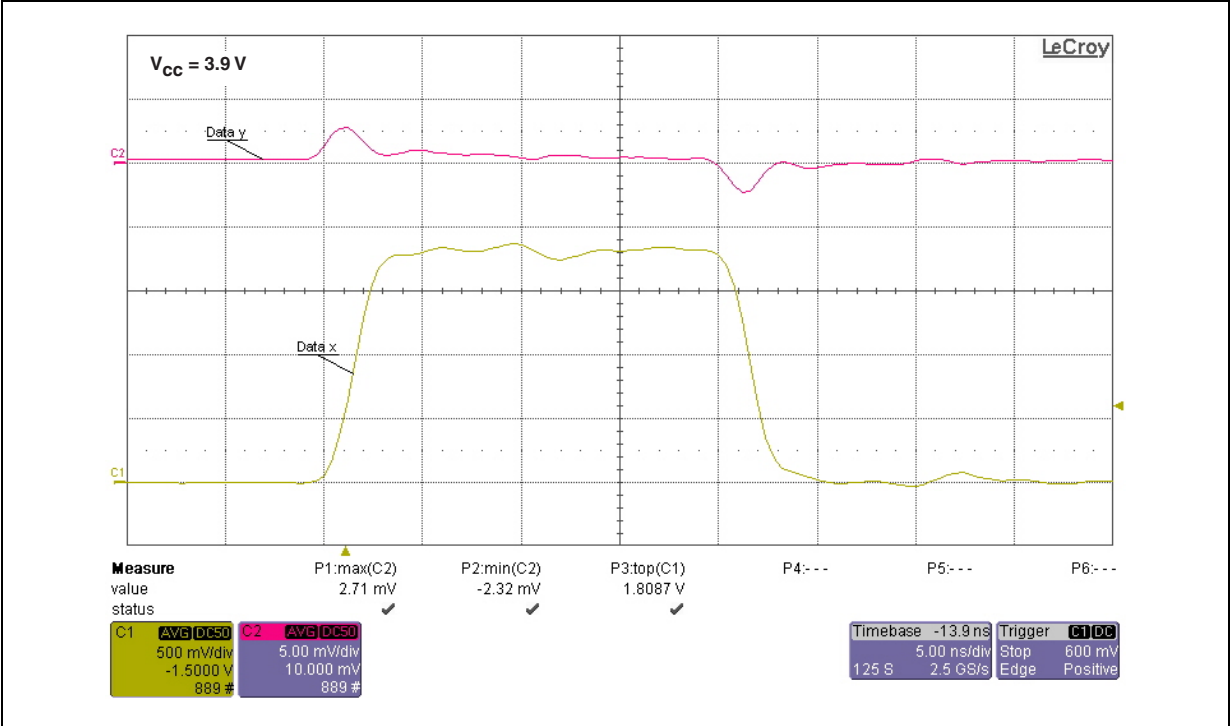


Figure 8. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on one input and one output

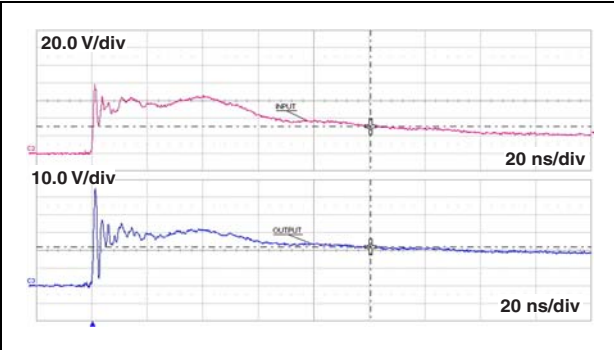
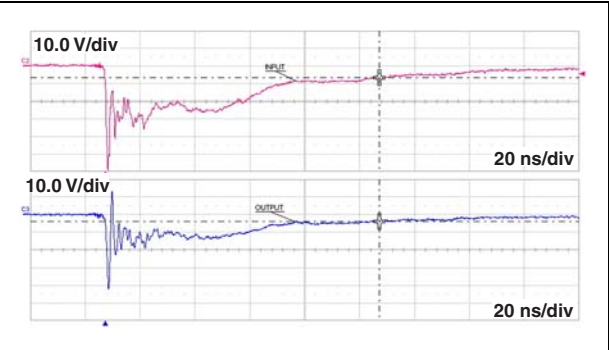
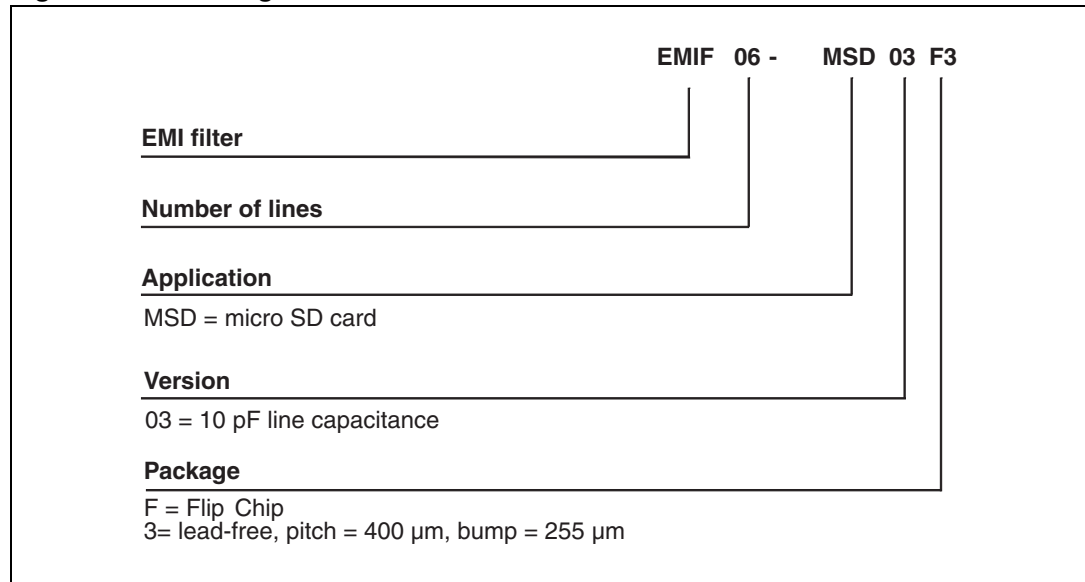


Figure 9. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on one input and one output



2 Ordering information scheme

Figure 10. Ordering information scheme



3 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 11. Package dimensions

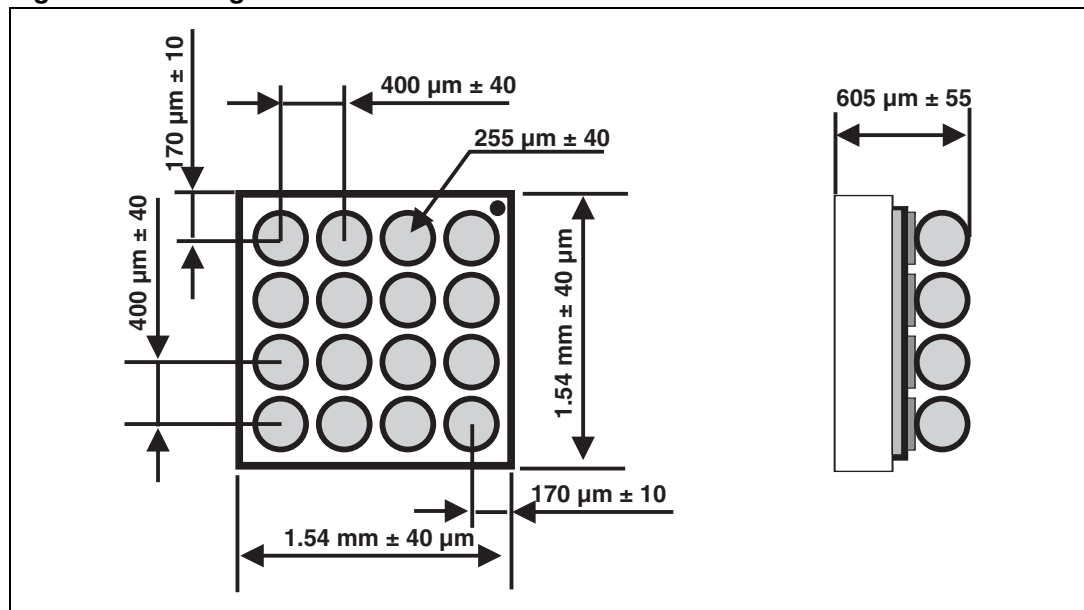


Figure 12. Footprint

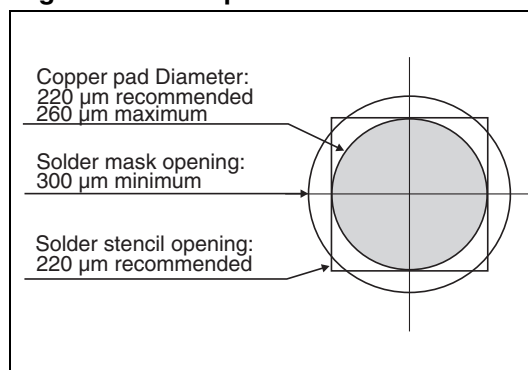


Figure 13. Marking

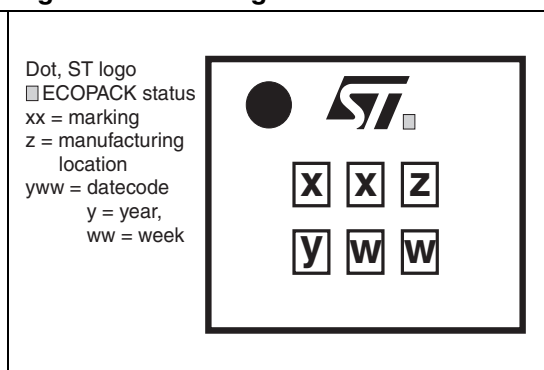
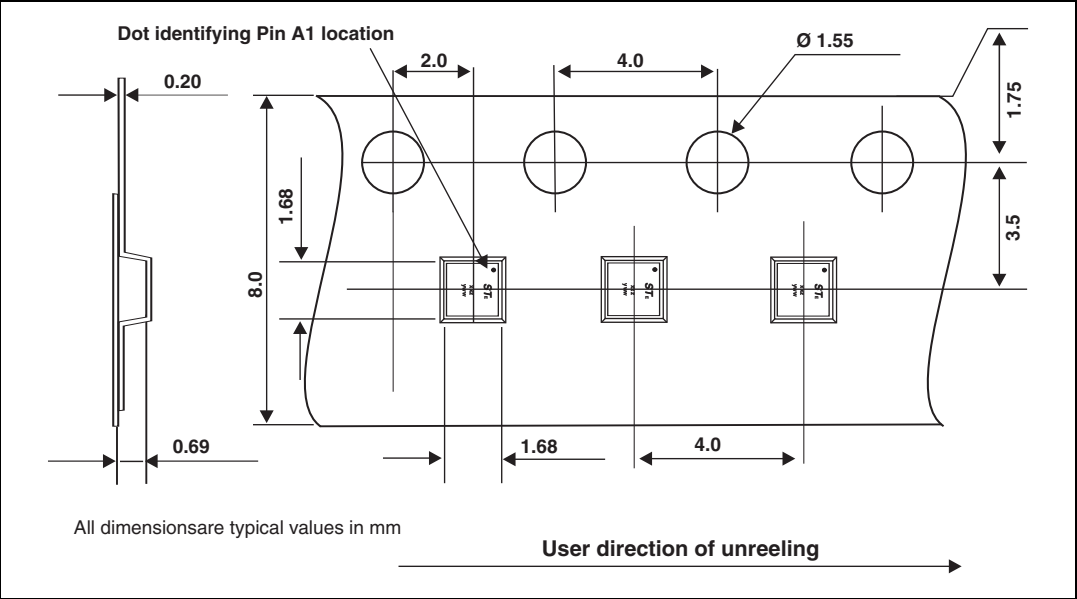


Figure 14. Tape and reel specification



4 Ordering information

Table 4. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|----------------|---------|-----------|--------|----------|------------------|
| EMIF06-MSD03F3 | JV | Flip Chip | 3.2 mg | 5000 | Tape and reel 7" |

Note: More information is available in the application notes:
AN2348: "Flip Chip: Package description and recommendations for use"
AN1751: "EMI Filters: Recommendations and measurements"

5 Revision history

Table 5. Document revision history

| Date | Revision | Changes |
|-------------|----------|--------------|
| 11-Jul-2011 | 1 | First issue. |

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